FORM PTO-1595	10-27-	1998	U.S. DEPARTMENT OF COMMERCE	
1-31-92 Patent and Trademark Office 7317/56603 OCT 1 9 1998 4				
7217/30003				
To the Honorable Commissioner of Patents and Trade	100865	852	copy thereof.	
1. Name of conveying hary(ies):		14mile min nomes	s of receiving party(les):	
Takashi Usui, Hisaki Hiraiwa and Takehiro Sugita	_			
Additional name(s) of conveying party(ies) attached? Yes X No		Name: Sony Corporation		
10-19-98		Internal Address:		
3. Nature of Conveyance:				
X Assignment		Street Address: 7-35 Kitashinagawa 6-chome Shinagawa-ku, Tokyo, Japan		
Security Agreement Change of Name		City State ZIP		
Other				
Execution Date: October 2, 1998		Additional name(s) &	& address(es) attached? Yes No	
4. Application number(s) or patent number(s):				
Approximation (v) of primite manipular.				
If this document is being filed together with a new application, the execution date of the application is:				
A. Patent Application No.(s)	ation, the execution date of u	B. Patent No.(s)		
09/139,434		D. Tatolit 140.(a)	1	
	Additional numbers attached	Yes X No	·	
Name and address of party to whom correspondence concerning document should be mailed:		6. Total number of	applications and patents involved:	
concerning document should be mailed.		ļ		
Names Jan II Maiali		<u> </u>		
Name: Jay H. Maioli Internal Address: Cooper & Dunham LLP		7. Total fee (37 CFR	R 3.41):\$40.00	
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		X Enclosed		
			stand day to a transaction of the same of	
Street Address: 1185 Avenue of the Americas		Authorized to be charged to deposit account 8. Deposit account number:		
Street Address. 1105 Avoide of the Afferivas		6. Deposit account number.		
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9. Statement and signature.				
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.				
Jan 1x Mainh				
Jay H. Maioli Name of Person Signing Signatur		October 14, 1998 Date		
Name of Letson Signing Signatur		Date		
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the office of Management and Budget, Paperwork Reduction Project. (0651-0011). Washington, D.C. 20503				

PATENT REEL: 9528 FRAME: 0238

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in CORRELATION DETECTING APPARATUS, ITS DETECTING METHOD AND COMMUNICATION APPARATUS AND ITS COMMUNICATION METHOD for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at6-7-35 Kitashinagawa, Shinagawa-Ku, Tokyo, Japan (hereinafter reference as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereof;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereof;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number 09/139,434 , Filing Date August 25, 1998

PATENT REEL: 9528 FRAME: 0239

S98P886US00

This assignment executed on the dates indicated below.

Takashi Usui	Cololin 2, 1998
Name of first or sole inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of first or sole inventor	Colole 2,1998 Date of this assignment
Signature of first or sole inventor	Date of this assignment
Hisaki Hiraiwa	October 2. 1998
Name of second inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of second inventor	
Jaranva Hishi Signature of second inventor	October 2, 1998 Date of this assignment
Signature of second inventor	Date of this assignment
Takehiro Sugita	October 2, 1998
Name of third inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of third inventor	
Jakehiro Sugita Signature of third inventor	October 2, 1998
Signature of third inventor	Date of this assignment

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RECORDED: 10/19/1998